BURR - BROWN®



AFE1115

HDSL/MDSL ANALOG FRONT END WITH VCXO

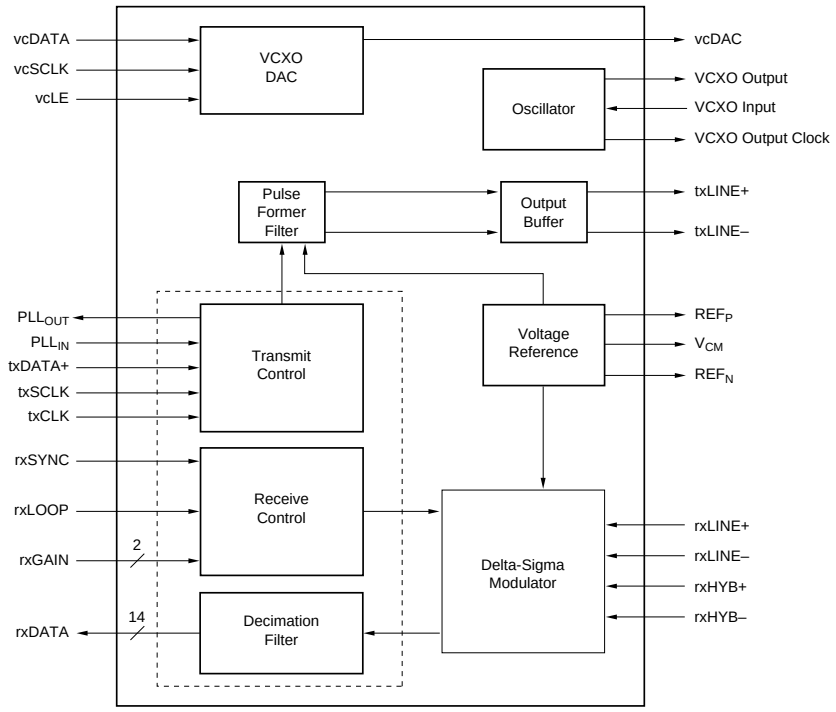
FEATURES

- COMPLETE HDSL ANALOG INTERFACE
- E1, T1 AND MDSL OPERATION
- VCXO AND VCXO CONTROL CIRCUITRY
- +5V ONLY (5V or 3.3V Digital)
- SCALEABLE DATA RATE
- 300mW POWER DISSIPATION
- 56-PIN SSOP

DESCRIPTION

Burr-Brown's Analog Front End greatly reduces the size and cost of an HDSL (High bit rate Digital Subscriber Line) system by providing all of the active analog circuitry needed to connect an HDSL digital signal processor to an external compromise hybrid and a HDSL line transformer. The transmit and receive filter responses automatically change with clock frequency—allowing the AFE1115 to operate over a range of data rates from 196kbps to 1.168Mbps.

Functionally, this unit consists of a transmit and a receive section with a VCXO (Voltage Controlled Crystal Oscillator) control DAC and VCXO circuitry. The transmit section generates, filters, and buffers outgoing 2B1Q data. The receive section filters and digitizes the symbol data received on the telephone line. Data to the VCXO and symbol data are sent to the AFE1115 via two serial interfaces; the receive data is available as a 14-bit parallel word. This IC operates on a single 5V supply. The digital circuitry in the unit can be connected to a supply from 3.3V to 5V. It is housed in a small 56-pin SSOP package.



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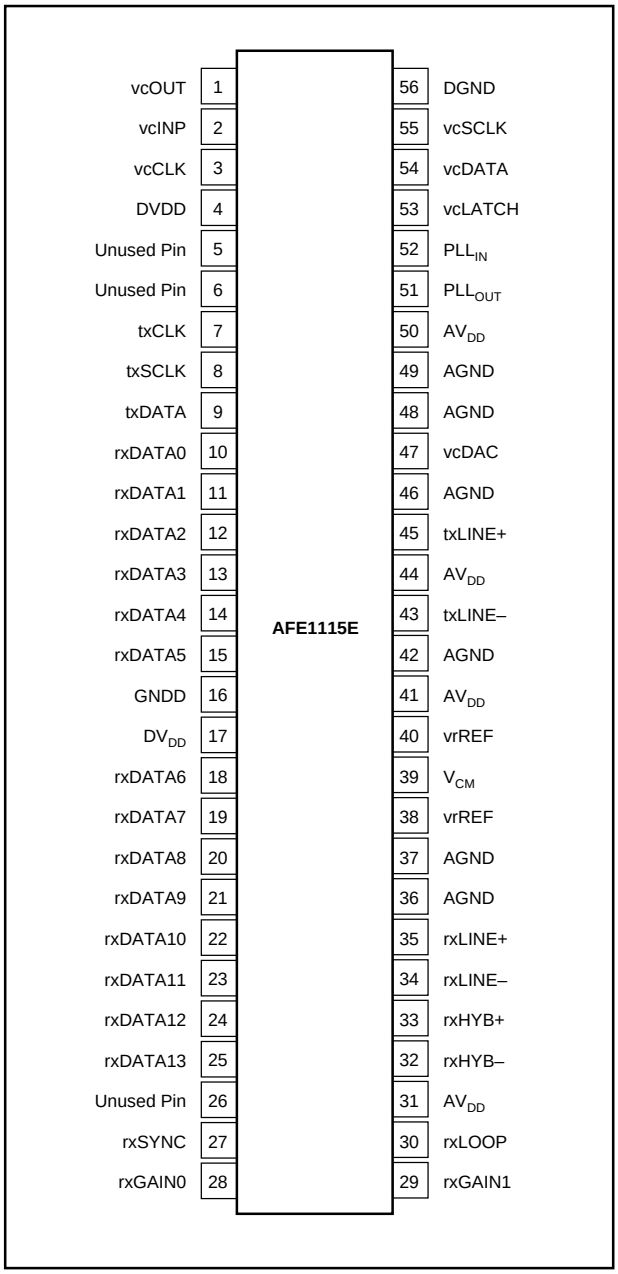
SPECIFICATIONS

Typical at 25°C, AV_{DD} = +5V, DV_{DD} = +3.3V, f_{tx} = 584kHz (E1 rate), unless otherwise specified.

PARAMETER	COMMENTS	AFE1115E MIN	AFE1115E TYP	AFE1115E MAX	UNITS
RECEIVE CHANNEL					
Number of Inputs	Differential	2			
Input Voltage Range	Balanced Differential(1)		±3.0		V
Common-Mode Voltage			+2.5		V
Input Impedance All Inputs			See Typical Performance Curves		
Input Capacitance			10		pF
Input Gain Matching	Line Input vs Hybrid Input		±2		%
Resolution		14			Bits
Programmable Gain	Three Gains: –3dB, 3dB, and 9dB	–3		+9	dB
Settling Time for Gain Change			6		Symbol Periods
Gain + Offset Error	Tested at Each Gain Range		5		%FSR(2)
Output Data Coding	Two's Complement				
Output Data Rate, rxSYNC(3)		98		584	kHz
TRANSMIT CHANNEL					
Transmit Clock Rate, f_{tx}	Symbol Rate	98		584	kHz
T1 Transmit –3dB Point	Bellcore TA-NWT-3017 Compliant		196		kHz
T1 Rate Power(4, 5)	See Test Method Section	13		14	dBm
E1 Transmit –3dB Point	ETSI RTR/TM-03036 Compliant		292		kHz
E1 Transmit Power(4, 5)	See Test Method Section	13		14	dBm
Pulse Output			See Typical Performance Curves		
Common-Mode Voltage, V_{CM}			AV_{DD}/2		V
Output Resistance(6)	DC to 1MHz		1		Ω
TRANSCEIVER PERFORMANCE					
Uncancelled Echo(7)	rxGAIN = –3dB, Loopback Enabled			–67	dB
	rxGAIN = –3dB, Loopback Disabled			–67	dB
	rxGAIN = 3dB, Loopback Disabled			–71	dB
	rxGAIN = 9dB, Loopback Disabled			–73	dB
VCXO PERFORMANCE					
VCXO Control DAC Resolution		8			Bits
VCXO Control DAC Output	Positive Full Scale Output		4.5		V
VCXO Control DAC Output	Negative Full Scale Output		0.5		V
VCXO Performance	See VCXO Circuit and Layout Section				
DIGITAL INTERFACE(6)					
Logic Levels					
V_{IH}	$\|I_{IH}\| < 10\mu A$	DV_{DD} –1		DV_{DD} +0.3	V
V_{IL}	$\|I_{IL}\| < 10\mu A$	–0.3		+0.8	V
V_{OH}	$I_{OH} = -20\mu A$	DV_{DD} –0.5			V
V_{OL}	$I_{OL} = 20\mu A$			+0.4	V
POWER					
Analog Power Supply Voltage	Specification		5		V
Analog Power Supply Voltage	Operating Range	4.75		5.25	V
Digital Power Supply Voltage	Specification		3.3		V
Digital Power Supply Voltage	Operating Range	3.15		5.25	V
Power Dissipation(4, 5, 8)	AV_{DD} = 5V, DV_{DD} = 3.3V,		300		mW
Power Dissipation(4, 5, 8)	$AV_{DD} = DV_{DD}$ = 5V		350		mW
PSRR			60		dB
TEMPERATURE RANGE					
Operating(6)		–40		+85	°C

NOTES: (1) With a balanced differential signal, the positive input is 180° out of phase with the negative input, therefore the actual voltage swing about the common-mode voltage on each pin is ±1.5V to achieve a total input range of ±3.0V or 6Vp-p. (2) FSR is Full-Scale Range. (3) The output data is available at twice the symbol rate with interpolated values. (4) With a pseudo-random equiprobable sequence of HDSL pulses; 13.5dBm applied to the transformer (16.5dBm output from txLINEP and txLINEN). (5) See the Test Method section of this data sheet for more information. (6) Guaranteed by design and characterization. (7) Uncancelled Echo is a measure of the total analog errors in the transmitter and receiver sections including the effect of non-linearity and noise. See the Discussion of Specifications sections of this data sheet for more information. (8) Power dissipation includes only the power dissipated with in the component and does not include power dissipated in the external loads. See the Discussion of Specifications section for more information.

PIN CONFIGURATION



PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER(1)	TEMPERATURE RANGE
AFE1115E	56-Pin Plastic SSOP	346	–40°C to +85°C

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.



ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PIN DESCRIPTIONS

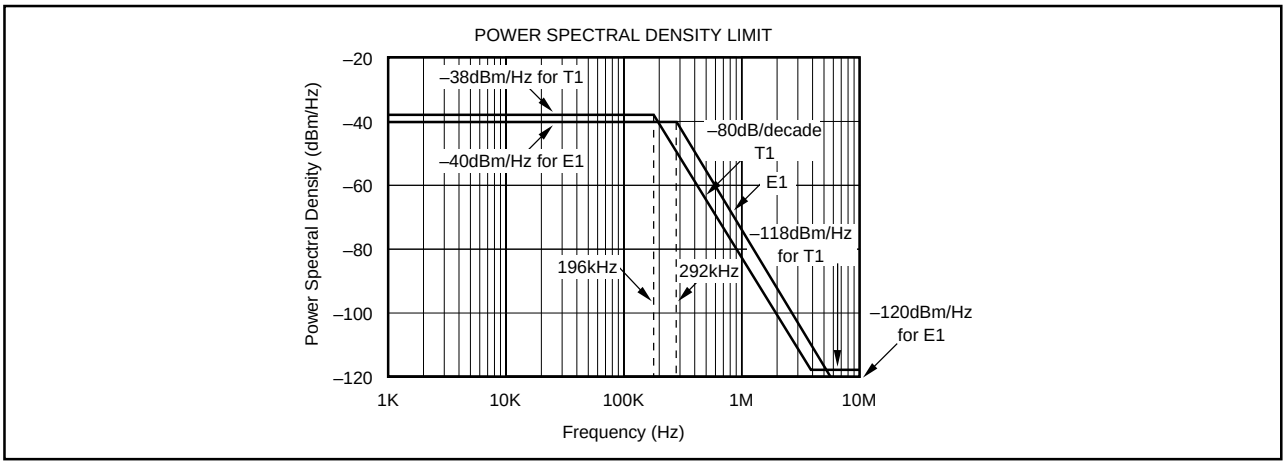
PIN #	TYPE	NAME	DESCRIPTION
1	Output	vcOUT	VCXO Output
2	Input	vcINP	VCXO Input
3	Output	vcCLK	VCXO Output Clock
4	Power	DVDD	Digital Supply (+3.3 to +5V)
5	NC	Unused Pin	
6	NC	Unused Pin	
7	Input	txCLK	Transmit Baud Clock (XMTLE signal) (1168kHz for E1)
8	Input	txSCLK	Transmit Serial Clock
9	Input	txDATA	Transmit Data Input
10	Output	rxDATA0	ADC Output Bit-0
11	Output	rxDATA1	ADC Output Bit-1
12	Output	rxDATA2	ADC Output Bit-2
13	Output	rxDATA3	ADC Output Bit-3
14	Output	rxDATA4	ADC Output Bit-4
15	Output	rxDATA5	ADC Output Bit-5
16	Ground	GNDD	Digital Ground
17	Power	DV_{DD}	Digital Supply (+3.3 to +5V)
18	Output	rxDATA6	ADC Output Bit-6
19	Output	rxDATA7	ADC Output Bit-7
20	Output	rxDATA8	ADC Output Bit-8
21	Output	rxDATA9	ADC Output Bit-9
22	Output	rxDATA10	ADC Output Bit-10
23	Output	rxDATA11	ADC Output Bit-11
24	Output	rxDATA12	ADC Output Bit-12
25	Output	rxDATA13	ADC Output Bit-13
26	NC	Unused Pin	(DV_{DD} may be connected for pinout compatibility with AFE1105)
27	Input	rxSYNC	ADC Sync Signal (392kHz for T1, 584kHz for E1)
28	Input	rxGAIN0	Receive Gain Control Bit-0
29	Input	rxGAIN1	Receive Gain Control Bit-1
30	Input	rxLOOP	Loopback Control Signal (loopback is enabled by positive signal)
31	Power	AV_{DD}	Analog Supply (+5V)
32	Input	rxHYB–	Negative Input from Hybrid Network
33	Input	rxHYB+	Positive Input from Hybrid Network
34	Input	rxLINE–	Negative Line Input
35	Input	rxLINE+	Positive Line Input
36	Ground	AGND	Analog Ground
37	Ground	AGND	Analog Ground
38	Output	vrREFP	Positive Reference Output
39	Output	V_{CM}	Common-mode Voltage (buffered)
40	Output	vrREFN	Negative Reference Output
41	Power	AV_{DD}	Analog Supply (+5V)
42	Ground	AGND	Analog Ground
43	Output	txLINE–	Negative Line Output
44	Power	AV_{DD}	Analog Supply (+5V)
45	Output	txLINE+	Positive Line Output
46	Ground	AGND	Analog Ground
47	Output	vcDAC	VCXO Control
48	Ground	AGND	Analog Ground
49	Ground	AGND	PLL Ground
50	Power	AV_{DD}	PLL Supply
51	Output	PLL_{OUT}	PLL Filter Output
52	Input	PLL_{IN}	PLL Filter Input
53	Input	vcLATCH	VCXO Control Latch Enable
54	Input	vcDATA	VCXO Control Data
55	Input	vcSCLK	VCXO Control Serial Clock
56	Ground	DGND	Digital Ground

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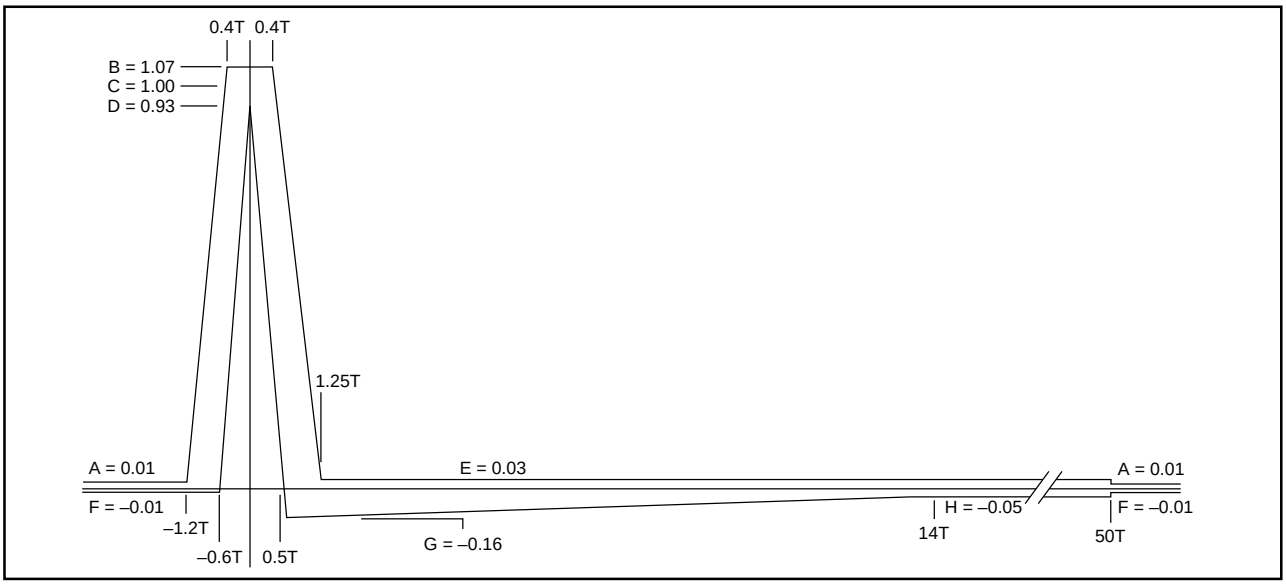
TYPICAL PERFORMANCE CURVES

At Output of Pulse Transformer

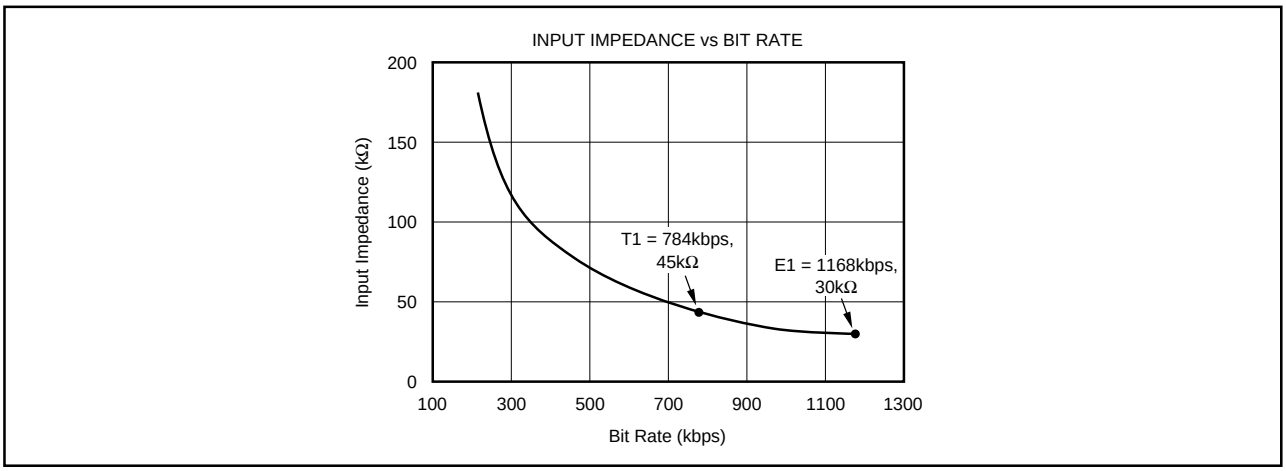
The curves shown below are measured at the line output of the HDSL transformer. Typical at 25°C, AV_{DD} = +5V, DV_{DD} = +3.3V, unless otherwise specified.



CURVE 1. Upper Bound of Power Spectral Density Measured at Output of HDSL Transformer.



CURVE 2. Transmitted Pulse Template and Actual Performance as Measured at Transformer Output.



CURVE 3. Input Impedance of rxLINE and rxHYB.

THEORY OF OPERATION

The transmit channel consists of a switched-capacitor pulse forming network followed by a differential line driver. The pulse forming network receives symbol data through a serial interface and generates a standard 2B1Q output waveform. The output meets the pulse mask and power spectral density requirements defined in European Telecommunications Standards Institute document RTR/TM-03036 for E1 mode and in sections 6.2.1 and 6.2.2.1 of Bellcore technical advisory TA-NWT-001210 for T1 mode. The differential line driver uses a composite output stage combining class B operation (for high efficiency driving large signals) with class AB operation (to minimize crossover distortion).

The receive channel is designed around a fourth-order delta sigma A/D converter. It includes a difference amplifier designed to be used with an external compromise hybrid for first order analog echo cancellation. A programmable gain amplifier with gains of –3dB to +9dB is also included. The delta sigma modulator operating at a 24X oversampling ratio produces a parallel 14-bit output at symbol rates up to 584kHz. The basic functionality of the AFE1115 is illustrated in Figure 1 shown below.

The receive channel operates by summing the two differential inputs, one from the line (rxLINE) and the other from the compromise hybrid (rxHYB). These two inputs are connected so that the hybrid signal is subtracted from the line signal. This connection is described in the paragraph titled "Echo Cancellation in the AFE". The equivalent gain for each input in the difference amp is one. The resulting signal then passes to a programmable gain amplifier which can be set for gains of –3dB through +9dB. The ADC converts the signal to a 14-bit digital word, rxD13-rxD0.

An independent VCXO control DAC and VCXO circuitry is also included on the chip. This VCXO is designed to be used in remote units for clock recovery. The VCXO is formed with the on-board circuitry plus external crystal and varactor diodes. The VCXO control DAC receives control data through a serial interface which sets a voltage level at the output of the DAC. The DAC output controls the frequency of the VCXO. To achieve specified analog performance when using the VCXO, the crystal frequency of the VCXO must be 48x the baud rate.

rxLOOP INPUT

rxLOOP is the loopback control signal. When enabled, the rxLINE+ and rxLINE– inputs are disconnected from the AFE. The rxHYB+ and rxHYB– inputs remain connected. Loopback is enabled by applying a positive signal (Logic 1) to rxLOOP.

ECHO CANCELLATION IN THE AFE

The rxHYB input is designed to be subtracted from the rxLINE input for first order echo cancellation. To accomplish this, note that the rxLINE input is connected to the same polarity signal at the transformer (positive to positive and negative to negative) while the rxHYB input is connected to opposite polarity through the compromise hybrid (negative to positive and positive to negative) as shown in Figure 2.

RECEIVE DATA CODING

The data from the receive channel A/D converter is coded in two's complement.

ANALOG INPUT	OUTPUT CODE (rxDATA)
Positive Full Scale	01111111111111
Mid Scale	00000000000000
Negative Full Scale	10000000000000

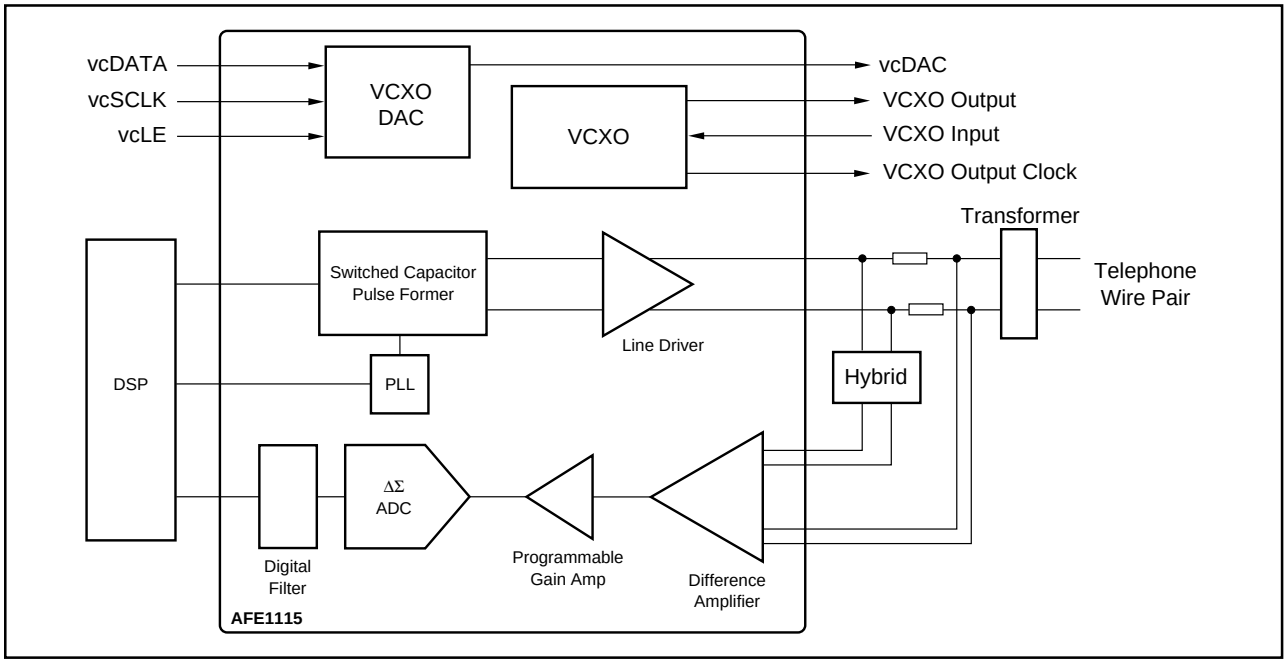


FIGURE 1. Functional Block Diagram of AFE1115 Circuit.

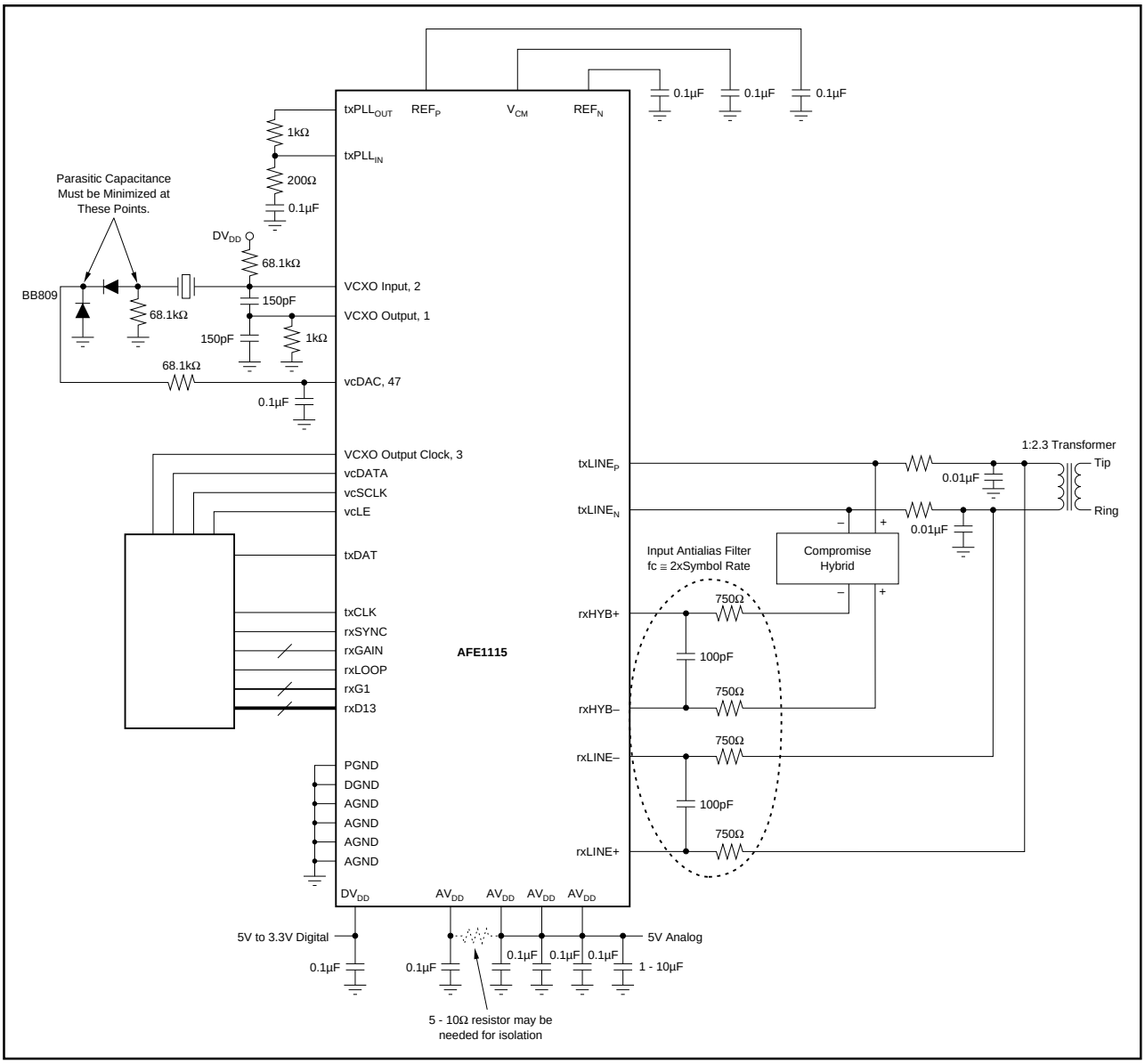


FIGURE 2. Basic Connection Diagram.

RECEIVE CHANNEL PROGRAMMABLE GAIN AMPLIFIER

The gain of the amplifier at the input of the Receive Channel is set by two gain control pins, rxGAIN1 and rxGAIN0. The resulting gain between –3dB and +9dB is shown below.

rxGAIN1	rxGAIN0	GAIN
0	0	–3dB
0	1	+3dB
1	0	+9dB

SCALEABLE DATA RATE

The AFE1115 scales operation with the clock frequency. All internal filters and the pulse former change frequency with the clock speed so that the unit can be used at different frequencies just by changing the clock speed.

rxHYB AND rxLINE INPUT ANTI-ALIASING FILTERS

An external input anti-aliasing filter is needed on the hybrid and line inputs as shown in the Basic Connection Diagram above. The –3dB frequency of the input anti-aliasing filter for the rxLINE and rxHYB differential inputs should be approximately 1MHz for E1 and T1 symbol rates. Suggested values for the filter are 750Ω for each of the two input resistors and 100pF for the capacitor. Together the two 750Ω resistors and the 100pF capacitor result in a 3dB frequency of just over 1MHz. The 750Ω input resistors will result in a minimal voltage divider loss with the input impedance of the AFE1115.

For speed less than E1, the anti-aliasing filters will give best performance with 3dB frequency approximately equal to two times the symbol rate. For instance, a 3dB frequency of 400kHz may be used for a single line symbol rate of 196k symbols per second.

rxHYB AND rxLINE INPUT COMMON-MODE OPTIONAL VOLTAGE

The AFE1115 will meet specifications with the application circuit shown in the Basic Connection Diagram (Figure 2) above. However, slightly improved performance may be obtained with the Hybrid input (rxHYB) and the Line input (rxLINE) set to a common mode voltage of 1.5V. The negative reference output pin (vrREFN, pin 40) provides a good 1.5V level to use to set the common-mode voltage. The circuit shown in Figure 3 can be used to set the common-mode voltage of the Line input to 1.5V.

A similar circuit can be used to set the Hybrid input to 1.5V. Another option for the Hybrid input is to design the external compromise hybrid so that the signal into the rsHYB inputs is centered at 1.5V. If the compromise hybrid circuit is AC coupled to the rxHYB inputs, an external pull-up resistor to vrREFN may be needed to center the input at 1.5V.

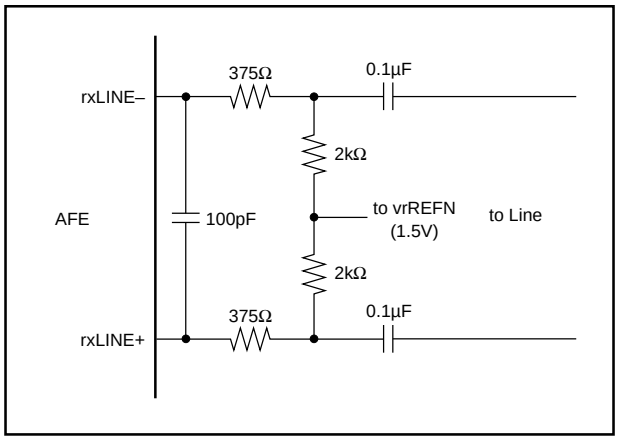
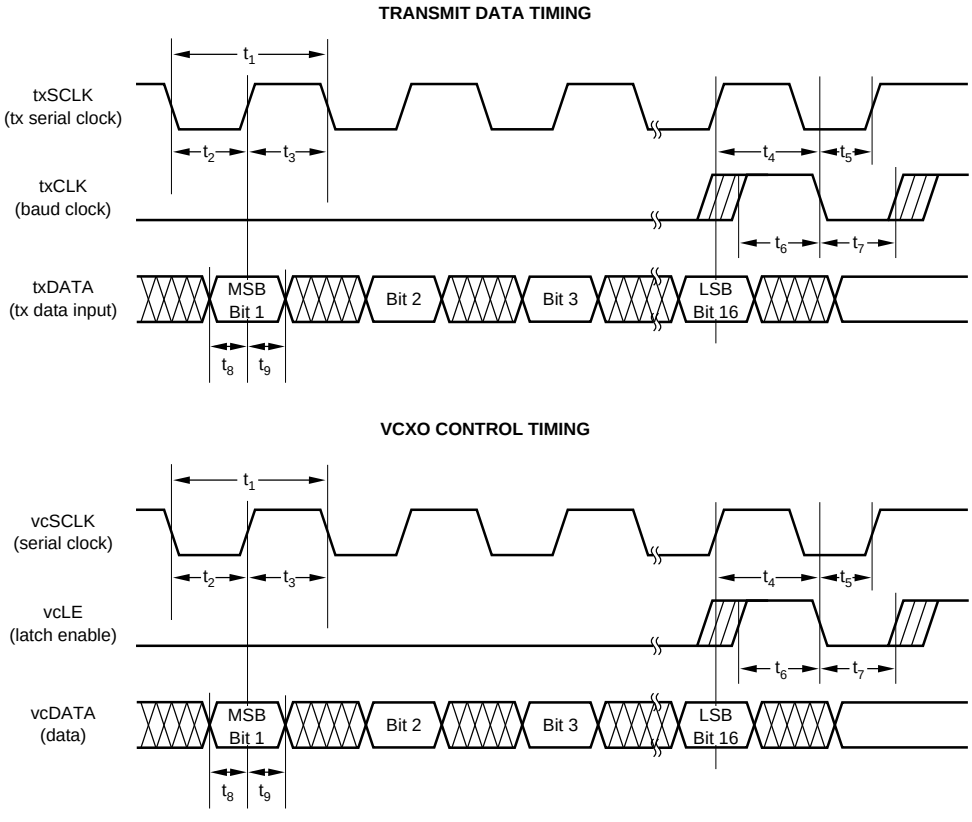


FIGURE 3. Optional rxLINE Input Common-mode Voltage Control.



SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
t_1	Serial Clock Period	35			ns
t_2	Serial Clock LOW	15			ns
t_3	Serial Clock HIGH	15			ns
t_4	Delay of 16th clock rising edge to falling edge of txCLK or vcLE	10			ns
t_5	Dealy of txCLK or vcLE to the next rising edge of Serial Clock	10			ns
t_6	txCLK or vcLE HIGH	15			ns
t_7	txCLK or vcLE LOW	15			ns
t_8	DATA setup time	10			ns
t_9	DATA hold time	10			ns

FIGURE 4. Timing Diagram.

TRANSMIT SYMBOL DATA

During each symbol period transmit symbol data are sent to the AFE1115 in serial format through the txDATA input pin. A 16 bit word is sent to the AFE1115 to determine the symbol that is transmitted by the AFE1115. The symbol data is contained in the first three bits of the data, the remaining 13 bits of the 16 bit word are ignored.

The most significant bit (MSB) is the transmit enable bit. When the MSB is a logic 0, a zero symbol only is transmitted regardless of the state of the other two bits. When the MSB is a logic 1, bits 2 and 3 determine the symbol transmitted as shown in the table below.

MSB - BIT 1	BIT 2	BIT 3	2B1Q SYMBOL
0	X	X	O
1	1	1	+3
1	1	0	+1
1	0	1	–1
1	0	0	–3

TABLE I. Transmit Symbol Data (txDATA). X = Don't Care.

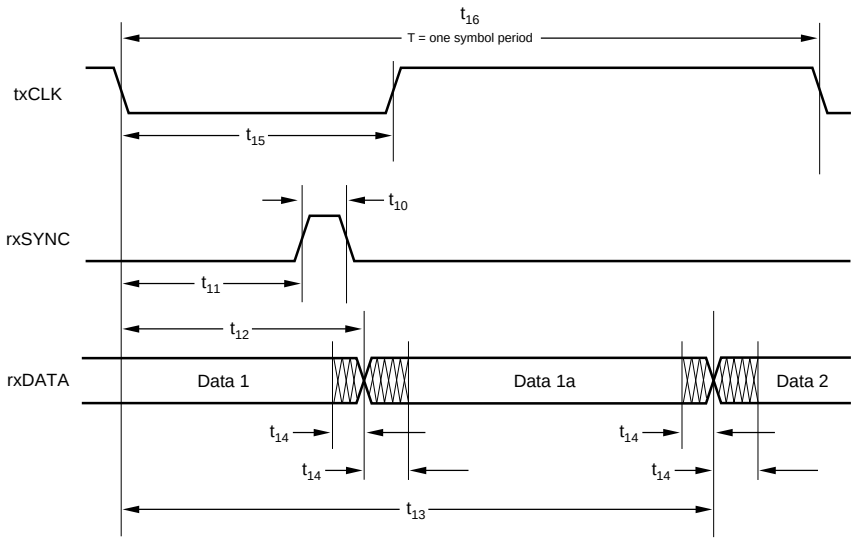
VCXO CONTROL D/A CONVERTER DATA

During each symbol period VCXO control D/A converter data is sent to the AFE1115 in serial format through the vcDATA input pin. A 16 bit word is sent to the AFE1115 to determine the output of the VCXO control D/A converter. The VCXO control D/A converter is connected to the VCXO circuit to control the VCXO frequency. The D/A converter input is contained in the first eight bits of the data, the remaining eight bits of the 16 bit word are ignored.

INPUT CODE (vcDATA) MSB	ANALOG OUTPUT
01111111XXXXXXXX	Negative Full Scale (+0.5V)
00000000XXXXXXXX	Mid Scale (+2.5V)
10000000XXXXXXXX	Positive Full Scale (+4.5V)

TABLE II. VCXO Control DAC Output. X = Don't Care.

RECEIVE TIMING



NOTES: (1) rxSYNC can shift to one of 48 discrete delay times from the leading edge of txCLK. (2) Timing is valid for load capacitance of 10pF or less. (3) It is recommended that rxDATA is read on the rising edge of rxSYNC. (4) Data 1a is an interpolated value between Data 1 and Data 2.

FIGURE 5. Receive Timing Diagram.

PARAMETER	DESCRIPTION	MIN	TYP	MAX	VALUE
t_{10}	rxSYNC Pulse Width	T/24			
t_{11}	Delay of rxSYNC from rising edge of txCLK, n = 0 to 47	nT/48 – T/96		nT/48 + T/96	
t_{12}	Nominal Time at Which rxDATA Changes from Data 1 to Data 1a		(n + 1.5) T/48		
t_{13}	Nominal Time at Which rxDATA Changes from Data 1a to Data 2		(n + 25.5) T/48		
t_{14}	Uncertainty of t12 and t13			20	ns
t_{15}	txCLK Pulse Width	T/16		15T/16	
t_{16}	Symbol Period, T	1.7		10.2	µs

TABLE III. Receive Timing (n = Delay Increments from txCLK).

RECEIVE TIMING

The rxSYNC signal controls portions of the A/D converter's decimation filter and the data output timing of the A/D converter. It is generated at the symbol rate by the user and must be synchronized with txCLK. The leading edge of rxSYNC can occur at the leading edge of txCLK or it can be shifted by the user in increments of 1/48 of a symbol period to one of 47 discrete delay times after the leading edge of txCLK.

The bandwidth of the A/D converter decimation filter is equal to one half of the symbol rate. The A/D converter data output rate is 2X the symbol rate. The specifications of the AFE1115 assume that one A/D converter output is used per symbol period and the other output is ignored. The Receive Timing Diagram above suggests using the rxSYNC pulse to read the first data output in a symbol period. Either data output may be used. Both data outputs may be used for more flexible post-processing.

DISCUSSION OF SPECIFICATIONS

UNCANCELLED ECHO

The key measure of transceiver performance is uncancelled echo. This measurement is made as shown in the diagram of Figure 6 and the measurement is made as follows. The AFE is connected to an output circuit including a typical 1:2.3 line transformer. The line is simulated by a 135Ω resistor. Symbol sequences are generated by the tester and applied both to the AFE and to the input of an adaptive filter. The output of the adaptive filter is subtracted from the AFE output to form the uncancelled echo signal. Once the filter taps have converged, the RMS value of the uncancelled echo is calculated. Since there is no far-end signal source or additive line noise, the uncancelled echo contains only noise and linearity errors generated in the transmitter and receiver.

The data sheet value for uncancelled echo is the ratio of the RMS uncancelled echo (referred to the receiver input through the receiver gain) to the nominal transmitted signal (13.5dBm into 135Ω, or 1.74Vrms). This echo value is measured under a variety of conditions: with loopback enabled (line input disabled); with loopback disabled under all receiver gain ranges; and with the line shorted (S_1 closed in Figure 6).

POWER DISSIPATION

Approximately 75% of the power dissipation in the AFE1115 is in the analog circuitry, and this component does not change with clock frequency. However, the power dissipation in the digital circuitry does decrease with lower clock frequency. In addition, the power dissipation in the digital section is decreased with operation from a smaller supply voltage, such as 3.3V. (The analog supply, must remain in the range 4.75V to 5.25V.)

The power dissipation listed in the specifications section applies under these normal operating conditions: 5V Analog Power Supply; 3.3V Digital Power Supply; E1 baud rate;

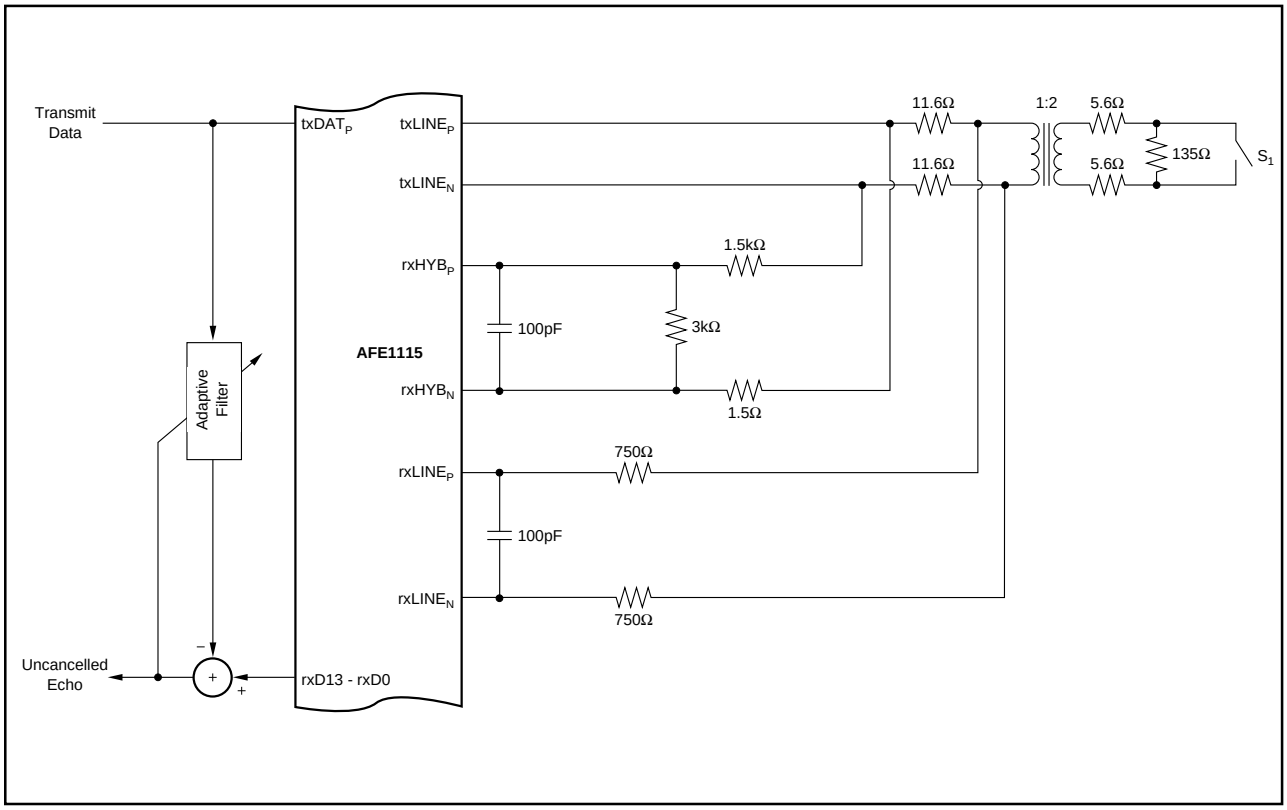


FIGURE 6. Uncancelled Echo Test Diagram.

13.5dBm delivered to the line; and a pseudo-random equiprobable sequence of HDSL pulses. The power dissipation specifications includes all power dissipated in the AFE1115, it does not include power dissipated in the external load.
The external power is 16.5dBm, 13.5dBm to the line and 13.5dBm to the impedance matching resistors. The external load power of 16.5dBm is 45mW. The typical power dissipation in the AFE1115 under various conditions is shown in

BIT RATE PER AFE1115 (Symbols/sec)	DVDD (V)	TYPICAL POWER DISSIPATION IN THE AFE1115 (mW)
1168 (E1)	3.3	300
1168 (E1)	5	350
784 (T1)	3.3	290
784 (T1)	5	330
292 (1/4 E1)	3.3	280
292 (1/4 E1)	5	300

TABLE IV. Typical Power Dissipation.

Table IV.

LAYOUT

The analog front end of an HDSL system has a number of conflicting requirements. It must accept and deliver digital outputs at fairly high rates of speed, generate a VCXO clock, phase-lock to a high-speed digital clock, and convert the line input to a high-precision (14-bit) digital output. Thus, there are really four sections of the AFE1115: the digital section, the phase-locked loop, the VCXO and the analog section.

DIGITAL LAYOUT

The power supply for the digital section of the AFE1115 can range from 3.3V to 5V. This supply should be decoupled to digital ground with a ceramic 0.1µF capacitor placed as close as possible to digital ground (DGND, pin 16) and digital power (DV_{DD}, pin 17). Ideally, both a digital power supply plane and a digital ground plane should run to and underneath the digital pins of the AFE1115 (pins 7 through 30). However, DV_{DD} may be supplied by a wide printed circuit board trance. A digital ground plane underneath all digital pins is strongly recommended. The VCXO circuit needs special attention for layout. There is a portion of the external VCXO circuitry which needs to be as far away as possible from a ground or power plane or other traces. See the discussion below in the section titled VCXO Circuit and Layout.

ANALOG LAYOUT

The phase-locked loop is powered from AV_{DD} (pin 50) and its ground is referenced to AGND (pin 49). Note that AV_{DD} must be in the 4.75V to 5.25V range. This portion of the AFE1115 should be decoupled with both 10µF Tantalum capacitor and a 0.1µF ceramic capacitor. The ceramic capacitor should be placed as close to the AFE1115 as possible. The placement of the Tantalum capacitor is not as critical, but should be close to the pin. In each case, the capacitor should be connected between AV_{DD} and AGND (pins 49 and 50). The capacitors should be placed in quiet analog areas rather than noisy digital areas.

In most systems, it will be natural to derive AV_{DD} for the phase-locked loop (PLL) from the AV_{DD} supply. A 5Ω to 10Ω resistor should be used to connect PLL AV_{DD} (pin 49) to the analog supply. This resistor in combination with the 10µF capacitor form a lowpass filter—keeping glitches on the analog supply from affecting the phase locked loop. Ideally, the phase-locked loop power supply would originate from the analog supply (via the 5Ω to 10Ω resistor) near the power connector for the printed circuit board. Likewise, the PLL ground should connect to a large PCB trace or small ground plane which returns to the power supply connector underneath the PLL AV_{DD} supply path. The PLL "ground plane" should also extend underneath PLL_{IN} and PLL_{OUT} (pins 51 and 52).

The remaining portion of the AFE1115 should be considered analog. The four non-PLL AGND pins (pins 36, 37, 42, and 46) should be connected directly to a common analog ground plane and all non-PLL AV_{DD} pins should be connected to an analog 5V power plane. Both of these planes should have a low impedance path to the power supply.

Ideally, all ground planes and traces and all power planes and traces should return to the power supply connector before being connected together (if necessary). Each ground and power pair should be routed over each other, should not overlap any portion of another pair, and the pairs should be separated by a distance of at least 0.25 inch (6mm). One exception is that the digital and analog ground planes should be connected together underneath the AFE1115 by a small trace.

VCXO CIRCUIT AND LAYOUT

The VCXO circuitry is shown in Figure 7. The basic VCXO circuit consists of on-chip control DAC, amplifiers, Schmidt triggers, and clock buffer along with an external crystal and varactor diodes. The control DAC output (vcDAC) varies the capacitance of the varactor diodes (D1 and D2), which controls the frequency at which the crystal circuit oscillates. The buffered clock output is available at pin 3, VCXO Clock Output.

Important Note: To achieve specified analog performance when using VCXO, the crystal frequency of the VCXO must be 48x the baud rate. In addition, the txCLK and the rxSYNC control signals must be derived from the VCXO clock so that the edges of the control signal are synchronized with the 48x crystal frequency. If these recommendations are followed, the key internal analog decisions are made at the time of minimum noise. As an example, for an E1 rate of 1168kbps, the symbol rate is 584k symbols per second. In this case the VCXO crystal frequency should be 48 x 584k = 28.032MHz. Likewise, for T1, the crystal frequency should be 18.816MHz.

The performance of the VCXO is critically dependent on the external components and printed circuit board layout that is used. The varactor diodes and the crystal are particularly important components.

The printed circuit board layout containing the two varactor diodes, D1 and D2, in the VCXO external circuitry is critical to the performance of the VCXO. In particular, the two connection points of the varactor diodes shown in the Figure 7 must have very low parasitic capacitance to ground to achieve the best tuning range possible. To achieve lowest parasitic capacitance to ground, there must be no ground plane or other PCB traces near these two points. Ground planes and other traces should be kept 1 cm away from these two points where possible.

Figure 8 shows an example of a printed circuit board layout of the sensitive VCXO circuitry for the circuit shown in Figure 7. There should be no ground planes, power planes or other traces in the white area indicated around the two sensitive points. The balance of the circuit board should be covered by ground planes where possible. With the circuit shown in Figure 7, these typical specifications were achieved.

Pull Range at 20MHz	±125ppm
Frequency Range of Crystal that can be used	10MHz to 28MHz
Crystal Frequency	48x baud rate

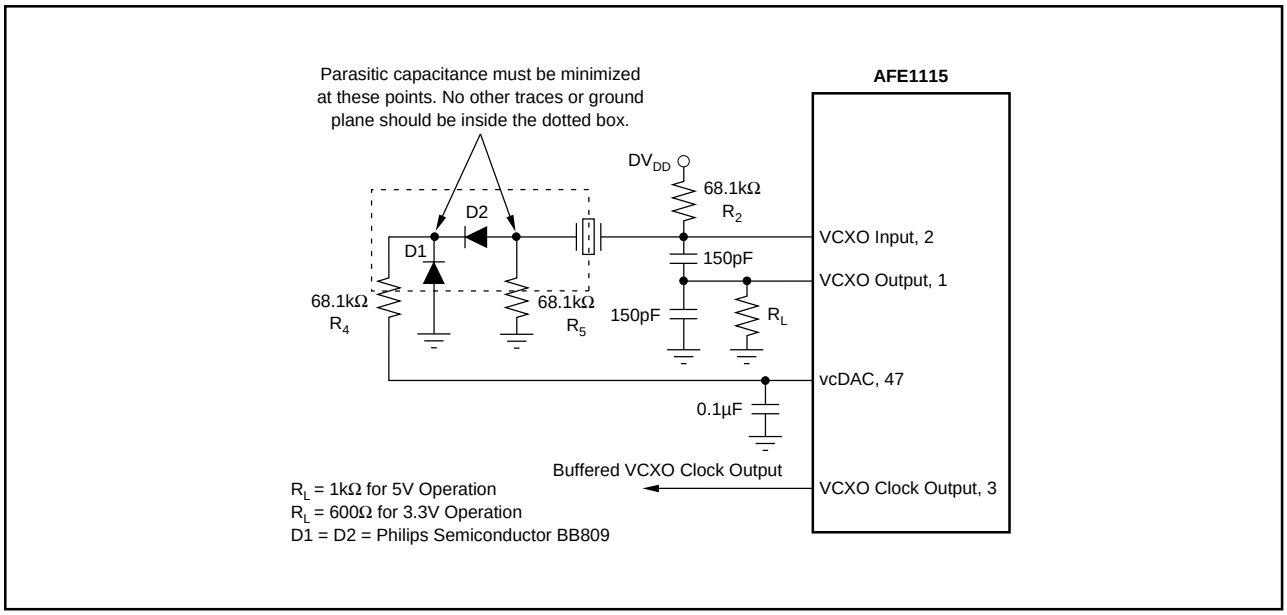


FIGURE 7. VCXO Circuitry.

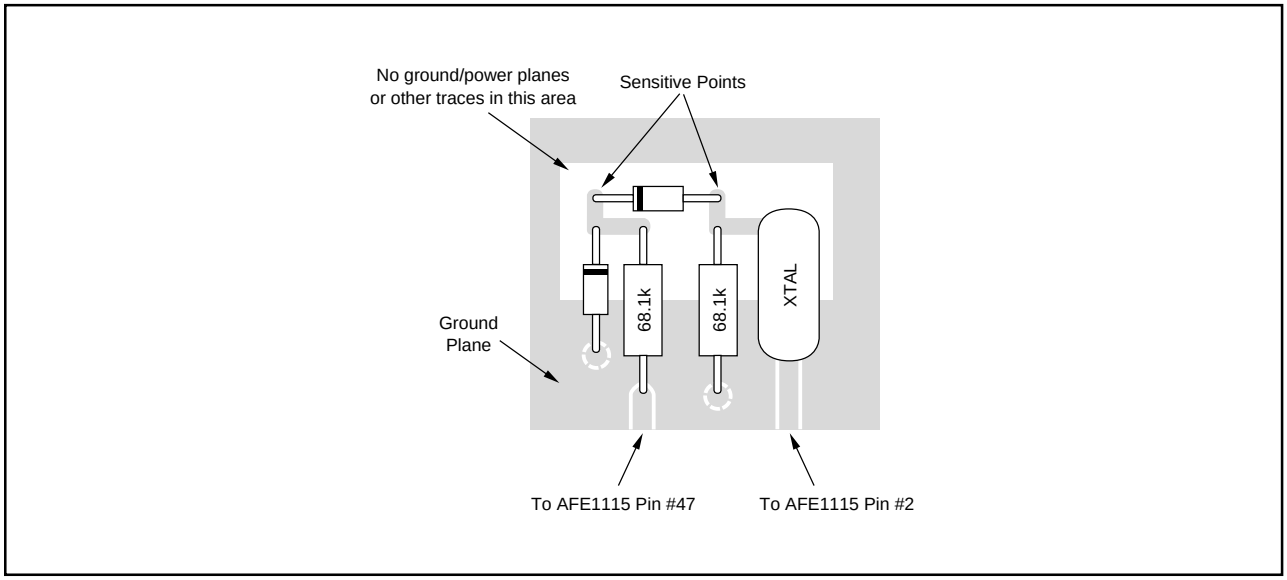


FIGURE 8. VCXO Circuit Layout, Approximately Two Times Actual Size.

PACKAGING INFORMATION

ORDERABLE DEVICE	STATUS(1)	PACKAGE TYPE	PACKAGE DRAWING	PINS	PACKAGE QTY
AFE1115E	ACTIVE	SSOP	DL	56	27
AFE1115E/1K	ACTIVE	SSOP	DL	56	1000

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

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